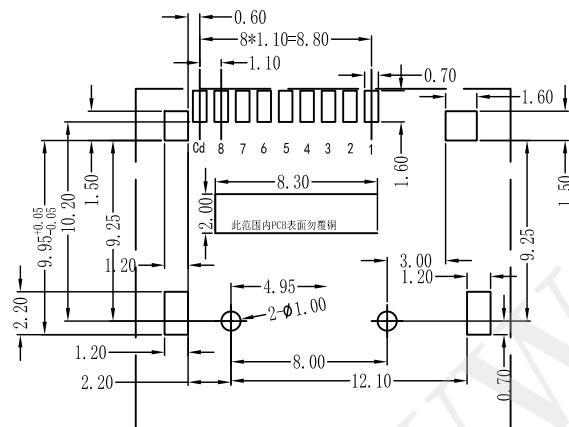
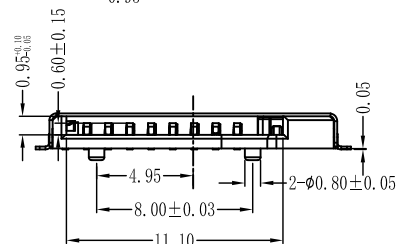
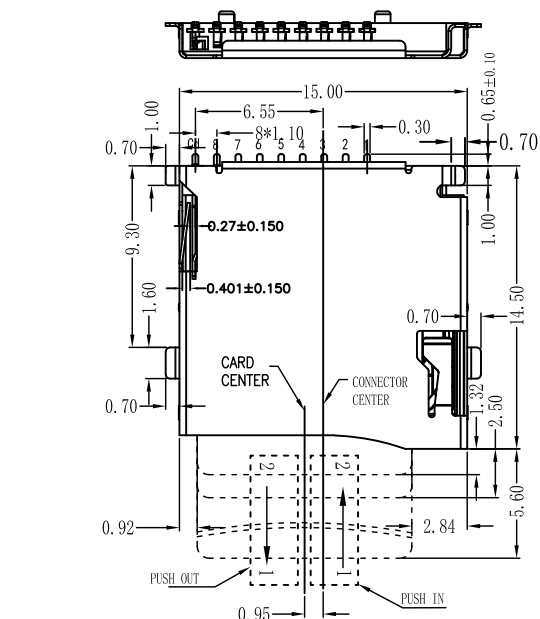
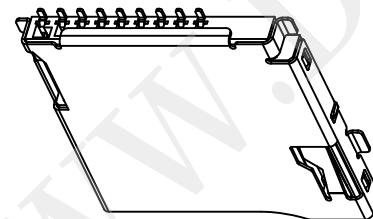
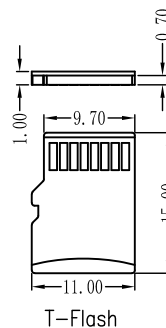
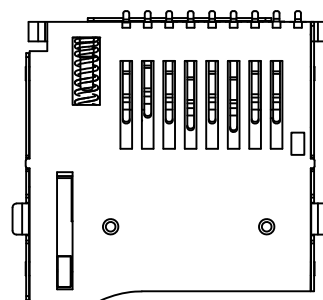
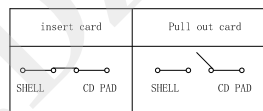
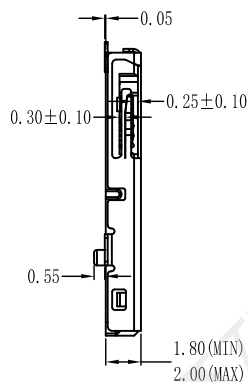
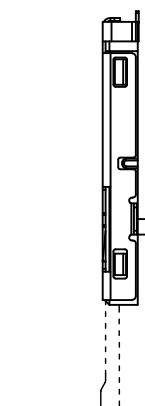




RECOMMENDED P.C.B HOLE LAYOUT
COMPONENT SIDE VIEW(TOLERANCE: ± 0.05)



PIN NO.	NAME	YTYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DATO	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)
	CD	CD	CD

NOTES:

1. MATERIAL:

HOUSING: LCP UL94-V0

CONTACT: COPPER ALLOY

SHELL: SUS201

2. ELECTROPLATING SPECIFICATIONS:

NICKEL UNDERLAYER 40U" MIN, CONTACT AREA

GOLD 0.5U"MIN, SOLDER LEG AREA MATTE TIN 80U"MIN.

3. PLATING:

CONTACT:GOLD FLASH PLATED.

SHELL: NICKEL PLATED.

4. ELECTRICAL CHARACTERISTICS

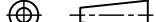
CONTACT CURRENT RATING :0.5A MAX

CONTACT RESISTANCE 100 mΩ MAX

INSULATION RESISTANCE 500 MO MIN



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: TF PUSH 外焊	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15					
X.* ±2* X.X* ±0.5*		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC77-TF09-200
				MOLD NO.	
		UNIT: mm [inch]		APPROVED BY:	DATE :
SCALE:1:1	SIZE: A4	邱敏	2014-02-23		